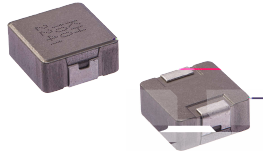


MDA Series

SMD Low Profile High Current Molded Inductor

Size 1350



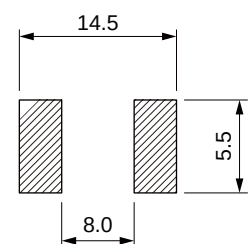
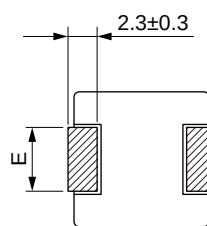
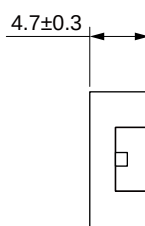
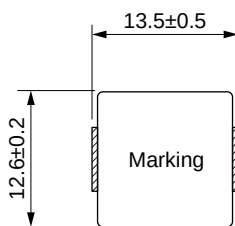
FEATURES

- Shielded construction
- Capable of corresponding high frequency.
- Low loss realized with low DCR.
- High performance (Isat) realized by metal dust core.
- Ultra low buzz noise, due to composite construction.
- 100% Lead(Pb)-Free and RoHS compliant.
- AEC-Q200 qualified
- Operating temperature: -55 to +155 °C (including self-temperature rise)
- Quantity: 500PCS

APPLICATION

- Headlamps, tail lamps and interior lighting
- HVAC
- Doors, window lift and seat control
- Audio subsystem
- Digital instrument cluster
- In-Vehicle Infotainment and navigation

Dimensions: [mm]

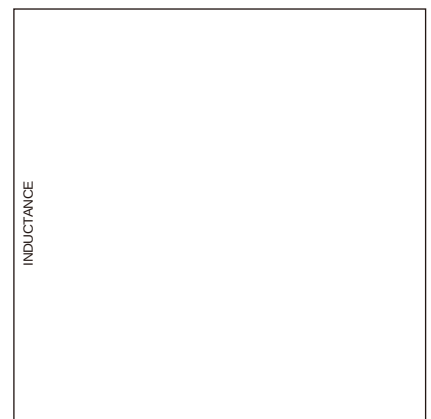


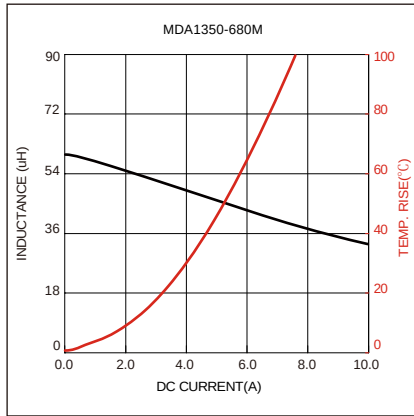
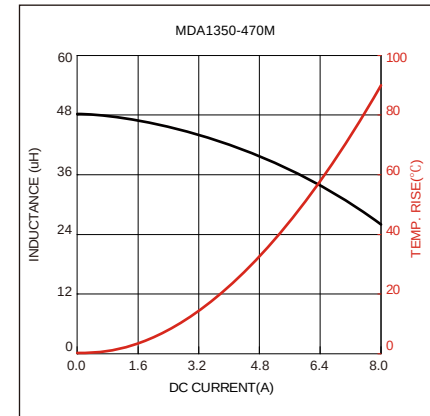
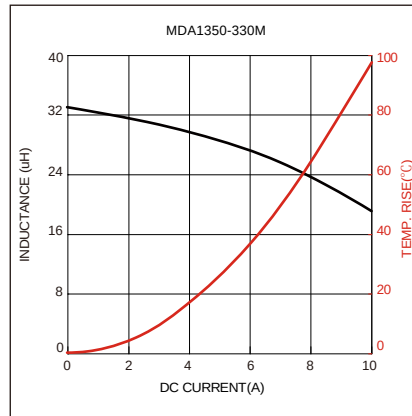
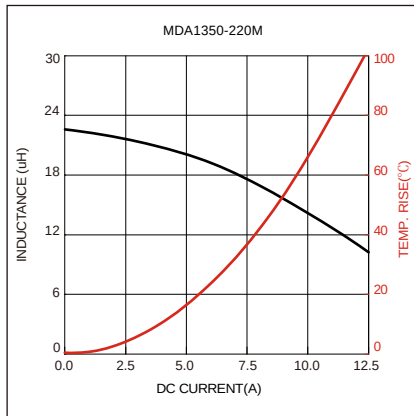
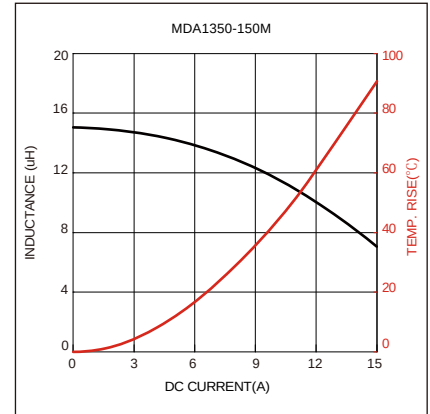
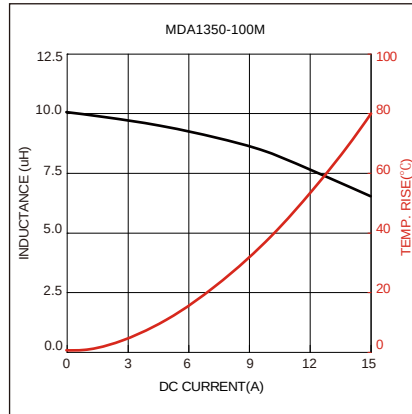
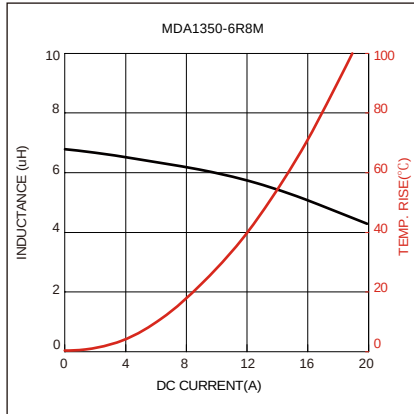
Land Pattern: [mm]

Electrical Properties:

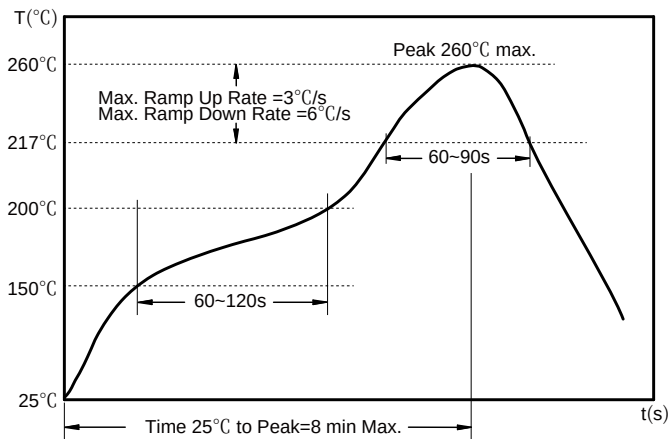
MDA1350-R22M	0.22	±20%	55.0	50.0	65.0	60.0	0.50	0.61	4.0±0.3
MDA1350-R33M	0.33	±20%	42.0	37.0	65.0	59.0	0.65	0.80	4.0±0.3
MDA1350-R47M	0.47	±20%	38.0	34.0	65.0	58.0	0.77	0.90	4.0±0.3
MDA1350-R68M	0.68	±20%	34.0	31.0	50.0	42.0	1.30	1.55	4.0±0.3
MDA1350-1R0M	1.00	±20%	30.0	27.0	40.0	34.0	1.60	1.90	4.0±0.3
MDA1350-1R5M	1.50	±20%	25.0	22.0	31.0	28.0	3.20	3.80	4.7±0.3
MDA1350-2R2M	2.20	±20%	17.0	15.5	26.0	23.0	4.10	4.80	4.7±0.3
MDA1350-3R3M	3.30	±20%	15.5	14.0	23.0	20.5	6.00	7.00	4.7±0.3
MDA1350-4R7M	4.70	±20%	14.0	12.5	18.5	16.0	8.80	10.2	4.7±0.3
MDA1350-6R8M	6.80	±20%	12.0	11.0	16.5	15.0	13.0	16.0	4.7±0.3
MDA1350-100M	10.0	±20%	10.0	9.0	13.0	10.5	19.2	22.0	4.7±0.3
MDA1350-150M	15.0	±20%	9.40	8.2	11.0	9.2	30.0	36.0	4.7±0.3

Typical Electrical Characteristics:





Soldering Reflow:



Preheat condition: $150 \sim 200^{\circ}\text{C} / 60 \sim 120 \text{ sec.}$

Allowed time above 217°C : 60~90 sec.

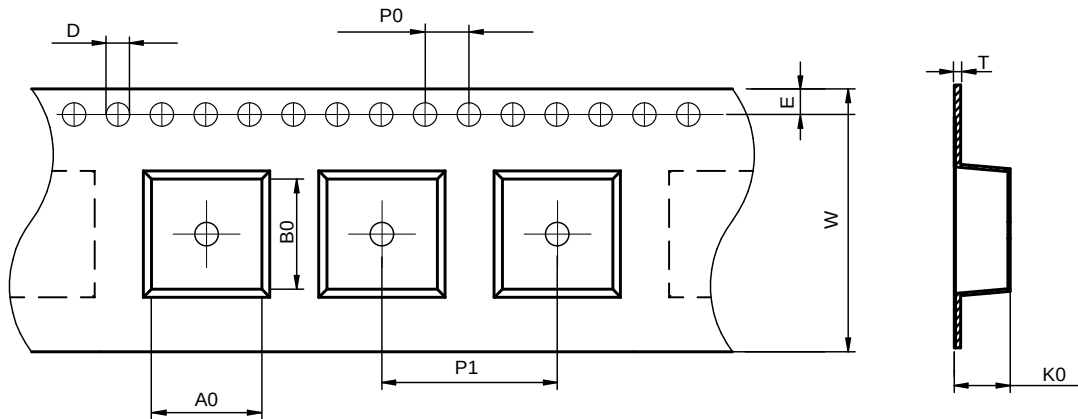
Max temperature: 260°C .

Max time at max temperature: 10 sec.

Allowed Reflow time: 2x max.

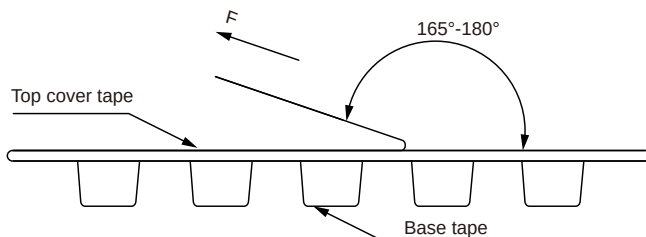
Packaging Information:

Tape Dimension :



Series	A0 (mm)	B0 (mm)	D (mm)	P0 (mm)	P1 (mm)	W (mm)	K0 (mm)	E (mm)	T (mm)
MDA1350	13.1 ± 0.1	14.0 ± 0.1	1.5 ± 0.1	4.0 ± 0.1	16.0 ± 0.1	24.0 ± 0.3	5.4 ± 0.1	1.75 ± 0.1	0.50 ± 0.05

Peel force of top cover tape:



The peel force of top cover tape shall be between 0.1 to 1.3 N

Product Marking:

Marking	KH+Printing (Inductance+period)
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